



CYPRESS

PLDC20RA10

Reprogrammable Asynchronous CMOS Logic Device

Features

- Advanced-user programmable macrocell
- CMOS EPROM technology for reprogrammability
- Up to 20 input terms
- 10 programmable I/O macrocells
- Output macrocell programmable as combinatorial or asynchronous D-type registered output
- Product-term control of register clock, reset and set and output enable
- Register preload and power-up reset
- Four data product terms per output macrocell
- Fast
 - Commercial
 - $t_{PD} = 15 \text{ ns}$
 - $t_{CO} = 15 \text{ ns}$
 - $t_{SU} = 7 \text{ ns}$

— Military/Industrial

$t_{PD} = 20 \text{ ns}$
 $t_{CO} = 20 \text{ ns}$
 $t_{SU} = 10 \text{ ns}$

• Low power

- I_{CC} max = 80 mA (Commercial)
- I_{CC} max = 85 mA (Military)

• High reliability

- Proven EPROM technology
- >2001V input protection
- 100% programming and functional testing
- Windowed DIP, windowed LCC, DIP, LCC, PLCC available

Functional Description

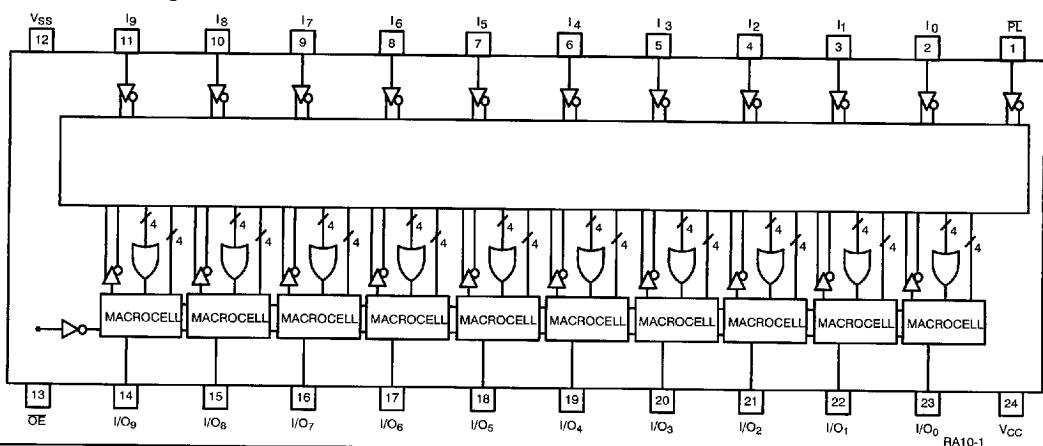
The Cypress PLDC20RA10 is a high-performance, second-generation program-

mable logic device employing a flexible macrocell structure that allows any individual output to be configured independently as a combinatorial output or as a fully asynchronous D-type registered output.

The Cypress PLDC20RA10 provides lower-power operation with superior speed performance than functionally equivalent bipolar devices through the use of high-performance 0.8-micron CMOS manufacturing technology.

The PLDC20RA10 is packaged in a 24 pin 300-mil molded DIP, a 300-mil windowed cerDIP, and a 28-lead square leadless chip carrier, providing up to 20 inputs and 10 outputs. When the windowed device is exposed to UV light, the 20RA10 is erased and can then be reprogrammed.

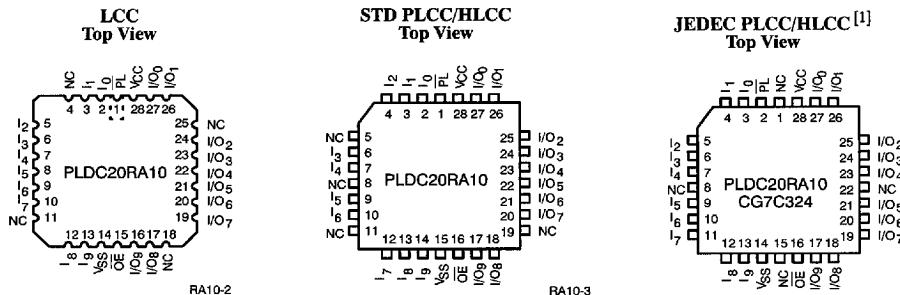
Logic Block Diagram



Selection Guide

| Generic Part Number | t _{PD} ns | | t _{SU} ns | | t _{CO} ns | | I _{CC} ns | |
|---------------------|--------------------|---------|--------------------|---------|--------------------|---------|--------------------|---------|
| | Com'l | Mil/Ind | Com'l | Mil/Ind | Com'l | Mil/Ind | Com'l | Mil/Ind |
| 20RA10-15 | 15 | | 7 | | 15 | | 80 | |
| 20RA10-20 | 20 | 20 | 10 | 10 | 20 | 20 | 80 | 85 |
| 20RA10-25 | | 25 | | 15 | | 25 | | 85 |
| 20RA10-35 | | 35 | | 20 | | 35 | | 85 |

Pin Configurations



Macrocell Architecture

Figure 1 illustrates the architecture of the 20RA10 macrocell. The cell dedicates three product terms for fully asynchronous control of the register set, reset, and clock functions, as well as, one term for control of the output enable function.

The output enable product term output is ANDed with the input from pin 13 to allow either product term or hardwired external control of the output or a combination of control from both sources. If product-term-only control is selected, it is automatically chosen for all outputs since, for this case, the external output enable pin must be tied LOW. The active polarity of each output may be programmed independently for each output cell and is subsequently fixed. Figure 2 illustrates the output enable options available.

When an I/O cell is configured as an output, combinatorial-only capability may be selected by forcing the set and reset product term outputs to be HIGH under all input conditions. This is achieved by programming all input term programming cells for these two product terms. Figure 3 illustrates the available output configuration options.

An additional four uncommitted product terms are provided in each output macrocell as resources for creation of user-defined logic functions.

Programmable I/O

Because any of the ten I/O pins may be selected as an input, the device input configuration programmed by the user may vary from a total of nine programmable plus ten dedicated inputs (a total of nineteen inputs) and one output down to a ten-input, ten-output configuration with all ten programmable I/O cells configured as outputs. Each input pin available in a given configuration is avail-

able as an input to the four control product terms and four uncommitted product terms of each programmable I/O macrocell that has been configured as an output.

An I/O cell is programmed as an input by tying the output enable pin (pin 13) HIGH or by programming the output enable product term to provide a LOW, thereby disabling the output buffer, for all possible input combinations.

When utilizing the I/O macrocell as an output, the input path functions as a feedback path allowing the output signal to be fed back as an input to the product term array. When the output cell is configured as a registered output, this feedback path may be used to feed back the current output state to the device inputs to provide current state control of the next output state as required for state machine implementation.

Preload and Power-Up Reset

Functional testability of programmed devices is enhanced by inclusion of register preload capability, which allows the state of each register to be set by loading each register from an external source prior to exercising the device. Testing of complex state machine designs is simplified by the ability to load an arbitrary state without cycling through long test vector sequences to reach the desired state. Recovery from illegal states can be verified by loading illegal states and observing recovery. Preload of a particular register is accomplished by impressing the desired state on the register output pin and lowering the signal level on the preload control pin (pin1) to a logic LOW level. If the specified preload set-up, hold and pulse width minimums have been observed, the desired state is loaded into the register. To insure predictable system initialization, all registers are preset to a logic LOW state upon power-up, thereby by setting the active LOW outputs to a logic HIGH.

Note:

1. The CG7C324 is the PLDC20RA10 packaged in the JEDEC-compatible 28-pin PLCC pinout. Pin function and pin order is identical for both PLCC pinouts. The principal difference is in the location of the "no connect" (NC) pins.



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PLDC20RA10

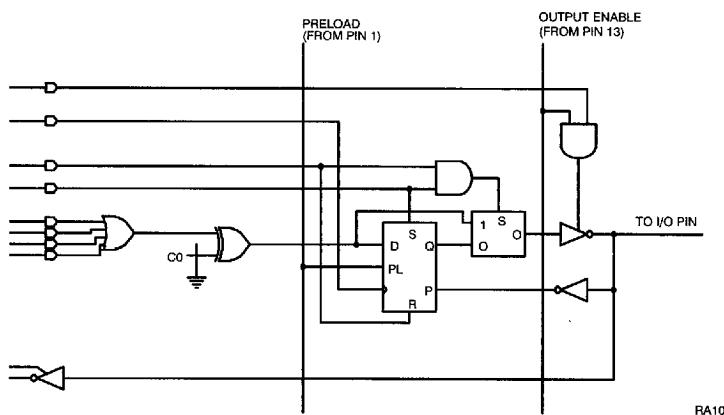


Figure 1. PLDC20RA10 Macrocell

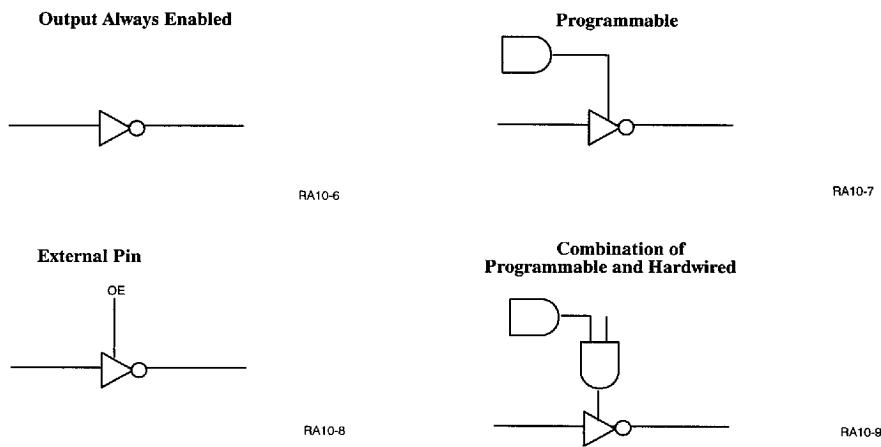


Figure 2. Four Possible Output Enable Alternatives for the PLDC20RA10

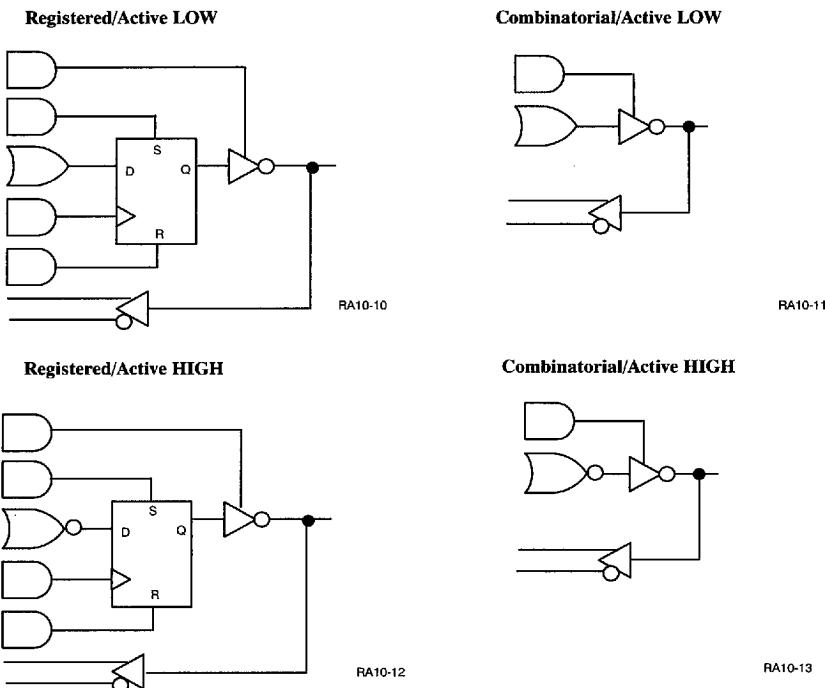


Figure 3. Four Possible Macrocell Configurations for the PLDC20RA10

Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature -65°C to +150°C

Ambient Temperature with

Power Applied -55°C to +125°C

Supply Voltage to Ground Potential

(Pin 24 to Pin 12) -0.5V to +7.0V

DC Voltage Applied to Outputs

in High Z State -0.5V to +7.0V

DC Input Voltage -3.0 V to + 7.0 V

Output Current into Outputs (LOW) 16 mA

Static Discharge Voltage >2001V
(per MIL-STD-883, Method 3015)

Latch-Up Current >200 mA

DC Program Voltage 13.0V

Operating Range

| Range | Ambient Temperature | V _{CC} |
|-------------------------|---------------------|-----------------|
| Commercial | 0°C to +75°C | 5V ± 10% |
| Industrial | -40°C to +85°C | 5V ± 10% |
| Military ^[2] | -55°C to +125°C | 5V ± 10% |

Electrical Characteristics Over the Operating Range^[3]

| Parameter | Description | Test Conditions | | | Min. | Max. | Unit |
|------------------|--|---|---------------------------|---------|---------|------|------|
| V _{OH} | Output HIGH Voltage | V _{CC} = Min., V _{IN} = V _{IH} or V _{IL} | I _{OH} = -3.2 mA | Com'l | 2.4 | | V |
| | | | I _{OH} = -2 mA | Mil/Ind | | | |
| V _{OL} | Output LOW Voltage | V _{CC} = Min., V _{IN} = V _{IH} or V _{IL} | I _{OL} = 8 mA | | | 0.5 | V |
| V _{IH} | Input HIGH Level | Guaranteed Input Logical HIGH Voltage for All Inputs ^[4] | | | 2.0 | | V |
| V _{IL} | Input LOW Level | Guaranteed Input Logical LOW Voltage for All Inputs ^[4] | | | | 0.8 | V |
| I _{IX} | Input Leakage Current | V _{SS} ≤ V _{IN} ≤ V _{CC} , V _{CC} = Max | | | -10 | +10 | µA |
| I _{OZ} | Output Leakage Current | V _{CC} = Max., V _{SS} ≤ V _{OUT} ≤ V _{CC} | | | -40 | +40 | µA |
| I _{SC} | Output Short Circuit Current ^[5] | V _{CC} = Max., V _{OUT} = 0.5V ^[6] | | | -30 | -90 | mA |
| I _{CC1} | Standby Power Supply Current | V _{CC} = Max., V _{IN} = GND Outputs Open | Com'l | | 75 | mA | |
| | | | Mil/Ind | | | | |
| I _{CC2} | Power Supply Current at Frequency ^[5] | V _{CC} = Max., Outputs Disabled (In High Z State) Device Operating at f _{MAX} | | | Com'l | 80 | mA |
| | | | | | Mil/Ind | 85 | mA |

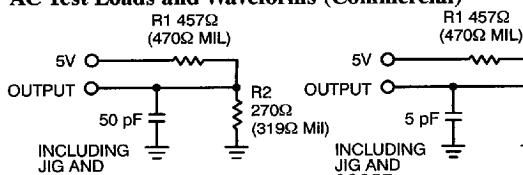
Capacitance^[5]

| Parameter | Description | Test Conditions | Max. | Unit |
|------------------|--------------------|--------------------------------------|------|------|
| C _{IN} | Input Capacitance | V _{IN} = 2.0 V @ f = 1 MHz | 10 | pF |
| C _{OUT} | Output Capacitance | V _{OUT} = 2.0 V @ f = 1 MHz | 10 | pF |

Notes:

2. T_A is the "instant on" case temperature.
3. See the last page of this specification for Group A subgroup testing information.
4. These are absolute values with respect to devicee ground and all overshoots due to system or tester noise are included.

5. Tested initially and after any design or process changes that may affect these parameters.
6. Not more than one output should be tested at a time. Duration of the short circuit should not be more than one second. V_{OUT} = 0.5 V has been chosen to avoid test problems caused by tester ground degradation.

AC Test Loads and Waveforms (Commercial)


RA10-14

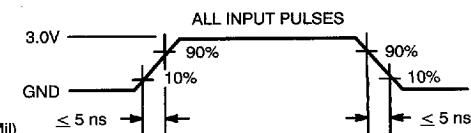
RA10-15

INCLUDING JIG AND SCOPE

(a)

(b)

INCLUDING JIG AND SCOPE



RA10-15

Equivalent to: THÉVENIN EQUIVALENT (Commercial)

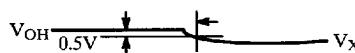
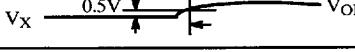
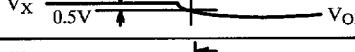
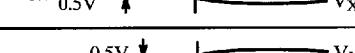
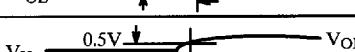
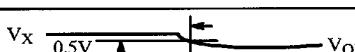
$$\text{OUTPUT} \rightarrow 170\Omega \rightarrow 1.86\text{V} = V_{thc}$$

Equivalent to: THÉVENIN EQUIVALENT (Military/Industrial)

$$\text{OUTPUT} \rightarrow 190\Omega \rightarrow 2.02\text{V} = V_{thc}$$

RA10-16

RA10-17

| Parameter | V_{th} | Output Waveform—Measurement Level | |
|--------------|-----------|---|---------|
| $t_{PXZ}(-)$ | 1.5V |  | RA10-18 |
| $t_{PXZ}(+)$ | 2.6V |  | RA10-19 |
| $t_{PZX}(+)$ | V_{thc} |  | RA10-20 |
| $t_{PZX}(-)$ | V_{thc} |  | RA10-21 |
| $t_{ER}(-)$ | 1.5V |  | RA10-22 |
| $t_{ER}(+)$ | 2.6V |  | RA10-23 |
| $t_{EA}(+)$ | V_{thc} |  | RA10-24 |
| $t_{EA}(-)$ | V_{thc} |  | RA10-25 |

(c)



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Switching Characteristics Over the Operating Range^[3, 7, 8]

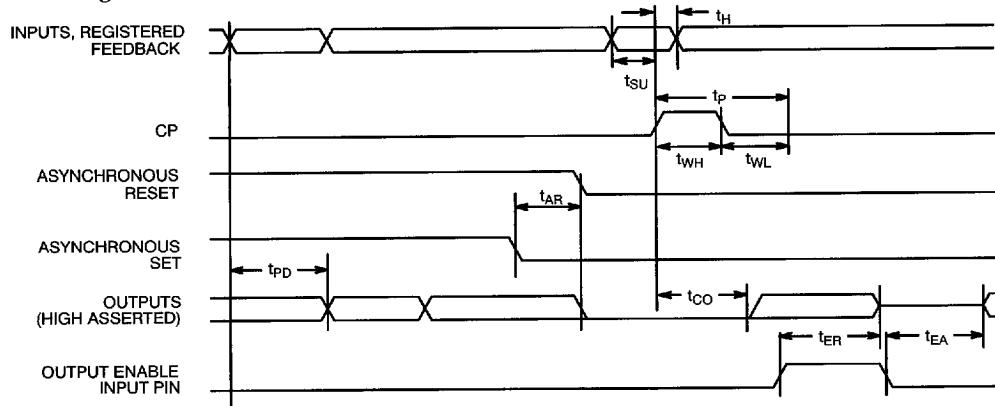
| Parameter | Description | Commercial | | | | Military/Industrial | | | | | | Unit | |
|------------------|--|------------|------|------|------|---------------------|------|------|------|------|------|------|--|
| | | -15 | | -20 | | -20 | | -25 | | -35 | | | |
| | | Min. | Max. | Min. | Max. | Min. | Max. | Min. | Max. | Min. | Max. | | |
| t _{PD} | Input or Feedback to Non-Registered Output | | 15 | | 20 | | 20 | | 25 | | 35 | ns | |
| t _{EA} | Input to Output Enable | | 15 | | 20 | | 20 | | 30 | | 35 | ns | |
| t _{ER} | Input to Output Disable | | 15 | | 20 | | 20 | | 30 | | 35 | ns | |
| t _{PZX} | Pin 13 to Output Enable | | 12 | | 15 | | 15 | | 20 | | 25 | ns | |
| t _{PXZ} | Pin 13 to Output Disable | | 12 | | 15 | | 15 | | 20 | | 25 | ns | |
| t _{CO} | Clock to Output | | 15 | | 20 | | 20 | | 25 | | 35 | ns | |
| t _{SU} | Input or Feedback Set-Up Time | 7 | | 10 | | 10 | | 15 | | 20 | | ns | |
| t _H | Hold Time | 3 | | 5 | | 3 | | 5 | | 5 | | ns | |
| t _P | Clock Period (t _{SU} + t _{CO}) | 22 | | 30 | | 30 | | 40 | | 55 | | ns | |
| t _{WH} | Clock Width HIGH ^[5] | 10 | | 13 | | 12 | | 18 | | 25 | | ns | |
| t _{WL} | Clock Width LOW ^[5] | 10 | | 13 | | 12 | | 18 | | 25 | | ns | |
| f _{MAX} | Maximum Frequency (1/t _P) ^[5] | 45.5 | | 33.3 | | 33.3 | | 25.0 | | 18.1 | | MHz | |
| t _S | Input of Asynchronous Set to Registered Output | | 15 | | 20 | | 20 | | 25 | | 40 | ns | |
| t _R | Input of Asynchronous Reset to Registered Output | | 15 | | 20 | | 20 | | 25 | | 40 | ns | |
| t _{ARW} | Asynchronous Reset Width ^[5] | 15 | | 20 | | 20 | | 25 | | 25 | | ns | |
| t _{ASW} | Asynchronous Set Width ^[5] | 15 | | 20 | | 20 | | 25 | | 25 | | ns | |
| t _{AR} | Asynchronous Set/Reset Recovery Time | 10 | | 12 | | 12 | | 15 | | 20 | | ns | |
| t _{WP} | Preload Pulse Width | 15 | | 15 | | 15 | | 15 | | 15 | | ns | |
| t _{SUP} | Preload Set-Up Time | 15 | | 15 | | 15 | | 15 | | 15 | | ns | |
| t _{HP} | Preload Hold Time | 15 | | 15 | | 15 | | 15 | | 15 | | ns | |

Notes:

7. Part (a) of AC Test Loads was used for all parameters except t_{EA}, t_{ER}, t_{PZX} and t_{PXZ}, which use part (b).
 8. The parameters t_{ER} and t_{PXZ} are measured as the delay from the input disable logic threshold transition to V_{OH} - 0.5 V for an enabled

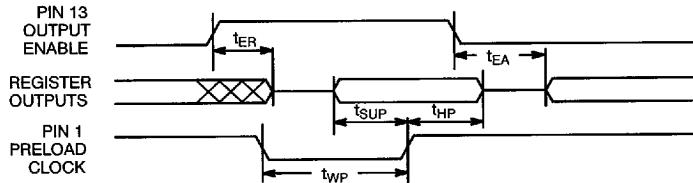
HIGH output or V_{OL} + 0.5 V for an enabled LOW output. Please see part (c) of AC Test Loads and Waveforms for waveforms and measurement reference levels.

Switching Waveform



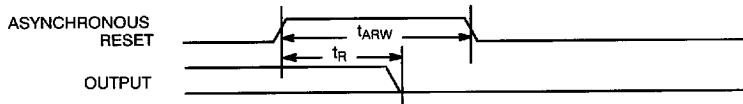
RA10-26

Preload Switching Waveform



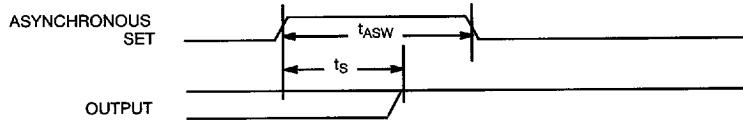
RA10-27

Asynchronous Reset



RA10-28

Asynchronous Set



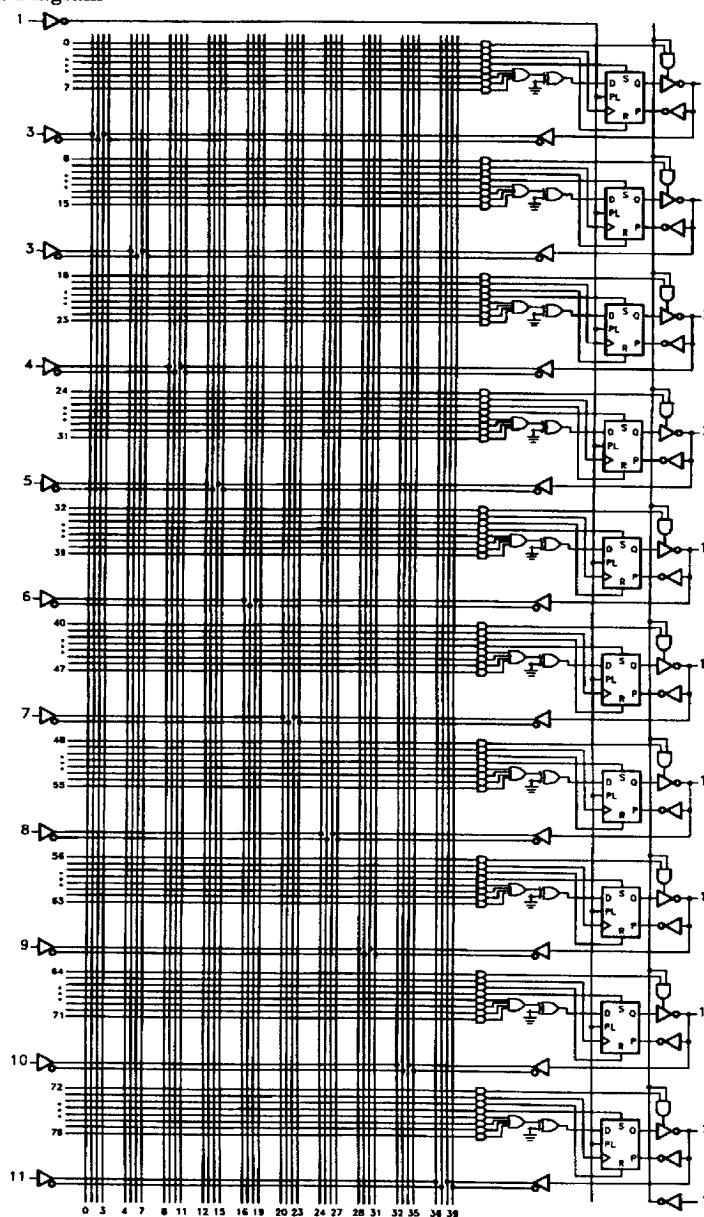
RA10-29



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PLDC20RA10

Functional Logic Diagram



RA10-30

2-43

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Ordering Information

| ICC2 | t_{PD} (ns) | t_{SU} (ns) | t_{CO} (ns) | Ordering Code | Package Name | Package Type | Operating Range |
|-------------|--------------------------------|--------------------------------|--------------------------------|----------------------|-------------------------|---------------------------------------|----------------------------|
| 80 | 15 | 7 | 15 | PLDC20RA10-15HC | H64 | 28-Pin Windowed Leaded Chip Carrier | Commercial |
| | | | | PLDC20RA10-15JC | J64 | 28-Lead Plastic Leaded Chip Carrier | |
| | | | | PLDC20RA10-15PC | P13 | 24-Lead (300-Mil) Molded DIP | |
| | | | | PLDC20RA10-15WC | W14 | 24-Lead (300-Mil) Windowed CerDIP | |
| | | | | CG7C324-A15HC | H64 | 28-Pin Windowed Leaded Chip Carrier | |
| | | | | CG7C324-A15JC | J64 | 28-Lead Plastic Leaded Chip Carrier | |
| 80 | 20 | 10 | 20 | PLDC20RA10-20HC | H64 | 28-Pin Windowed Leaded Chip Carrier | Commercial |
| | | | | PLDC20RA10-20JC | J64 | 28-Lead Plastic Leaded Chip Carrier | |
| | | | | PLDC20RA10-20PC | P13 | 24-Lead (300-Mil) Molded DIP | |
| | | | | PLDC20RA10-20WC | W14 | 24-Lead (300-Mil) Windowed CerDIP | |
| | | | | CG7C324-A20HC | H64 | 28-Pin Windowed Leaded Chip Carrier | |
| | | | | CG7C324-A20JC | J64 | 28-Lead Plastic Leaded Chip Carrier | |
| 85 | 20 | 10 | 20 | PLDC20RA10-20DI | D14 | 24-Lead (300-Mil) CerDIP | Industrial |
| | | | | PLDC20RA10-20JI | J64 | 28-Lead Plastic Leaded Chip Carrier | |
| | | | | PLDC20RA10-20PI | P13 | 24-Lead (300-Mil) Molded DIP | |
| | | | | PLDC20RA10-20WI | W14 | 24-Lead (300-Mil) Windowed CerDIP | |
| | | | | PLDC20RA10-20DMB | D14 | 24-Lead (300-Mil) CerDIP | Military |
| | | | | PLDC20RA10-20HMB | H64 | 28-Pin Windowed Leaded Chip Carrier | |
| | | | | PLDC20RA10-20LMB | L64 | 28-Square Leadless Chip Carrier | |
| | | | | PLDC20RA10-20QMB | Q64 | 28-Pin Windowed Leadless Chip Carrier | |
| | | | | PLDC20RA10-20WMB | W14 | 24-Lead (300-Mil) Windowed CerDIP | |
| | | | | PLDC20RA10-25DI | D14 | 24-Lead (300-Mil) CerDIP | Industrial |
| 85 | 25 | 15 | 25 | PLDC20RA10-25JI | J64 | 28-Lead Plastic Leaded Chip Carrier | |
| | | | | PLDC20RA10-25PI | P13 | 24-Lead (300-Mil) Molded DIP | |
| | | | | PLDC20RA10-25WI | W14 | 24-Lead (300-Mil) Windowed CerDIP | |
| | | | | PLDC20RA10-25DMB | D14 | 24-Lead (300-Mil) CerDIP | Military |
| | | | | PLDC20RA10-25HMB | H64 | 28-Pin Windowed Leaded Chip Carrier | |
| | | | | PLDC20RA10-25LMB | L64 | 28-Square Leadless Chip Carrier | |
| | | | | PLDC20RA10-25QMB | Q64 | 28-Pin Windowed Leadless Chip Carrier | |
| | | | | PLDC20RA10-25WMB | W14 | 24-Lead (300-Mil) Windowed CerDIP | |
| | | | | PLDC20RA10-35DI | D14 | 24-Lead (300-Mil) CerDIP | Industrial |
| | | | | PLDC20RA10-3JI | J64 | 28-Lead Plastic Leaded Chip Carrier | |
| 85 | 35 | 20 | 35 | PLDC20RA10-35PI | P13 | 24-Lead (300-Mil) Molded DIP | |
| | | | | PLDC20RA10-35WI | W14 | 24-Lead (300-Mil) Windowed CerDIP | |
| | | | | PLDC20RA10-35DMB | D14 | 24-Lead (300-Mil) CerDIP | Military |
| | | | | PLDC20RA10-35HMB | H64 | 28-Pin Windowed Leaded Chip Carrier | |
| | | | | PLDC20RA10-35LMB | L64 | 28-Square Leadless Chip Carrier | |
| | | | | PLDC20RA10-35QMB | Q64 | 28-Pin Windowed Leadless Chip Carrier | |
| | | | | PLDC20RA10-35WMB | W14 | 24-Lead (300-Mil) Windowed CerDIP | |



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PLDC20RA10

**MILITARY SPECIFICATIONS
Group A Subgroup Testing**

DC Characteristics

| Parameter | Subgroups |
|-----------------|-----------|
| V _{OH} | 1, 2, 3 |
| V _{OL} | 1, 2, 3 |
| V _{IH} | 1, 2, 3 |
| V _{IL} | 1, 2, 3 |
| I _{IX} | 1, 2, 3 |
| I _{OZ} | 1, 2, 3 |
| I _{CC} | 1, 2, 3 |

2

Switching Characteristics

| Parameter | Subgroups |
|------------------|-----------|
| t _{PD} | 9, 10, 11 |
| t _{PZX} | 9, 10, 11 |
| t _{CO} | 9, 10, 11 |
| t _{SU} | 9, 10, 11 |
| t _H | 9, 10, 11 |

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